

MOS FIELD EFFECT TRANSISTOR 2SK2415, 2SK2415-Z

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK2415 is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

FEATURES

• Low On-Resistance

RDS(on)1 = 0.10 Ω MAX. (@ VGS = 10 V, ID = 4.0 A) RDS(on)2 = 0.15 Ω MAX. (@ VGS = 4 V, ID = 4.0 A)

• Low Ciss Ciss = 570 pF TYP.

QUALITY GRADE

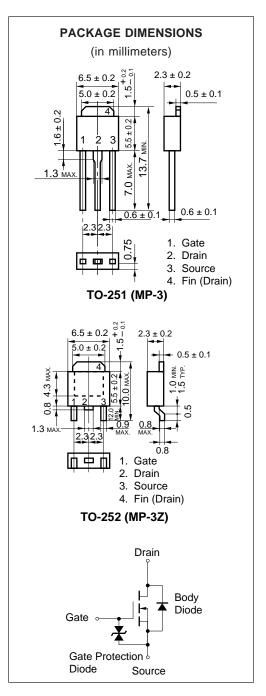
Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	VDSS	60	V
Gate to Source Voltage	Vgss	±20	V
Drain Current (DC)	I _{D(DC)}	±8.0	Α
Drain Current (pulse)*	ID(pulse)	±32	Α
Total Power Dissipation (Tc = 25 °C)	P _{T1}	20	W
Total Power Dissipation (Ta = 25 °C)	P _{T2}	1.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current**	las	8.0	Α
Single Avalanche Energy**	Eas	6.4	mJ

- * PW \leq 10 μ s, Duty Cycle \leq 1 %
- ** Starting Tch = 25 °C, Rg = 25 Ω , Vgs = 20 V \rightarrow 0



The information in this document is subject to change without notice.

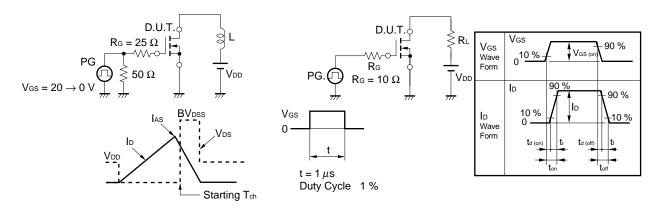


ELECTRICAL CHARACTERISTICS (TA = 25 °C)

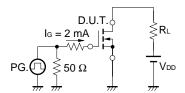
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-State Resistance	RDS(on)1		0.07	0.10	Ω	Vgs = 10 V, ID = 4.0 A
Drain to Source On-State Resistance	R _{DS(on)2}		0.10	0.15	Ω	Vgs = 4 V, ID = 4.0 A
Gate to Source Cutoff Voltage	V _{GS(off)}	1.0	1.6	2.0	V	V _{DS} = 10 V, I _D = 1 mA
Forward Transfer Admittance	yfs	5.0	8.4		S	V _{DS} = 10 V, I _D = 4.0 A
Drain Leakage Current	IDSS			10	μΑ	V _{DS} = 60 V, V _{GS} = 0
Gate to Source Leakage Current	Igss			±10	μΑ	Vgs = ±20 V, Vps = 0
Input Capacitance	Ciss		570		pF	V _{DS} = 10 V
Output Capacitance	Coss		290		pF	Vgs = 0
Reverse Transfer Capacitance	Crss		75		pF	f = 1 MHz
Turn-On Delay Time	td(on)		5		ns	ID = 4.0 A
Rise Time	tr		60		ns	VGS(on) = 10 V
Turn-Off Delay Time	td(off)		75		ns	V _{DD} = 30 V
Fall Time	tf		40		ns	$R_G = 10 \Omega$
Total Gate Charge	Q _G		21		nC	ID = 8.0 A
Gate to Source Charge	Qgs		2.0		nC	V _{DD} = 48 V
Gate to Drain Charge	Q _{GD}		6.5		nC	V _G S = 10 V
Body Diode Forward Voltage	VF(S-D)		1.0		V	IF = 8.0 A, VGS = 0
Reverse Recovery Time	trr		85		ns	IF = 8.0 A, VGS = 0
Reverse Recovery Charge	Qrr		200		nC	di/dt = 100 A/μs

Test Circuit 1 Avalanche Capability

Test Circuit 2 Switching Time

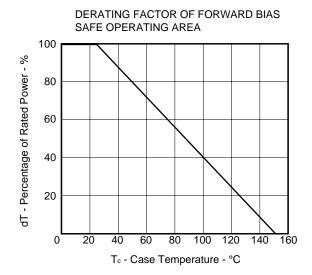


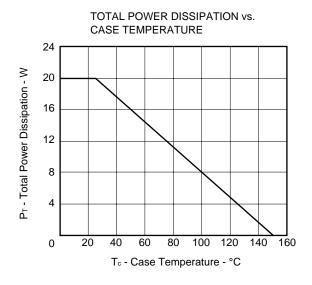
Test Circuit 3 Gate Charge



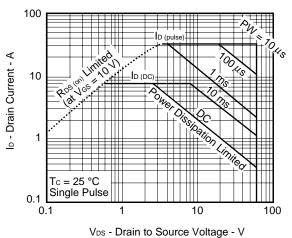
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

TYPICAL CHARACTERISTICS (TA = 25 °C)

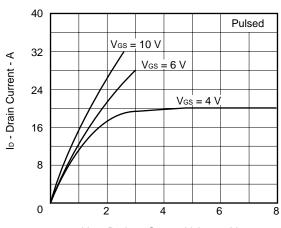






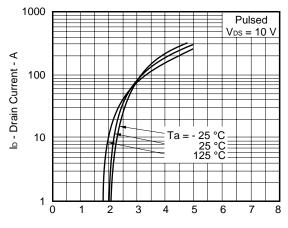




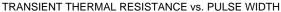


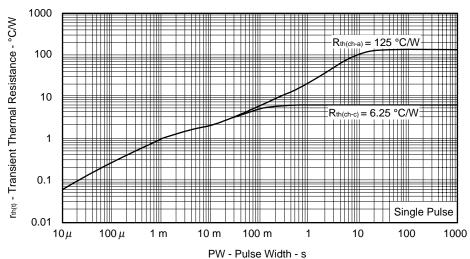
 $V_{\text{\scriptsize DS}}$ - Drain to Source Voltage - V

FORWARD TRANSFER CHARACTERISTICS

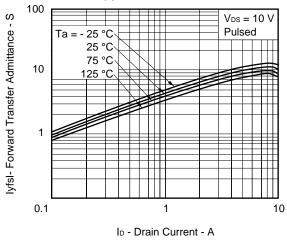


V_{GS} - Gate to Source Voltage - V

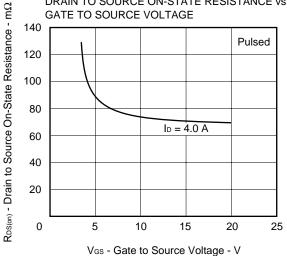




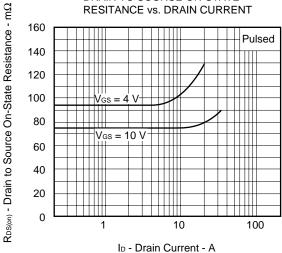
FORWARD TRANSFER ADMITTANCE vs. **DRAIN CURRENT**



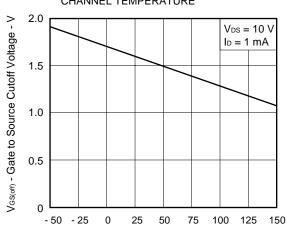
DRAIN TO SOURCE ON-STATE RESISTANCE vs.



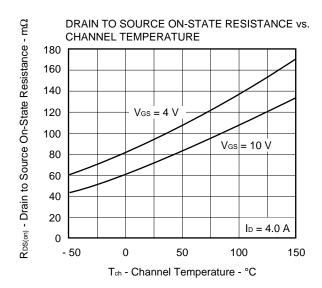
DRAIN TO SOURCE ON-STATE RESITANCE vs. DRAIN CURRENT

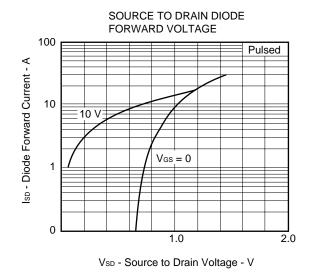


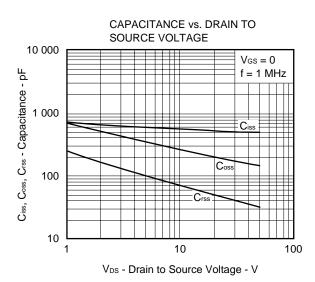
GATE TO SOURCE CUTOFF VOLTAGE vs. **CHANNEL TEMPERATURE**

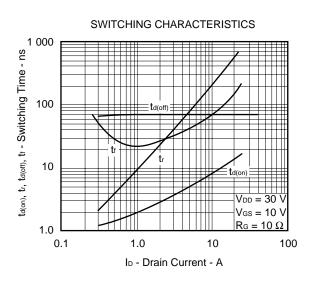


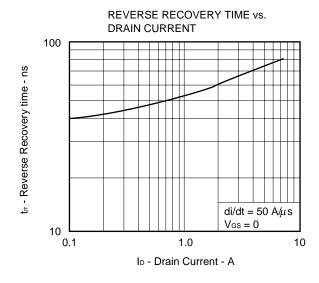
Tch - Channel Temperature - °C

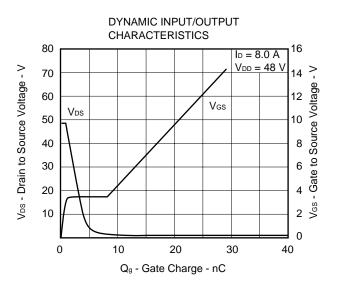


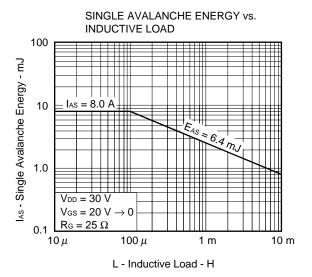


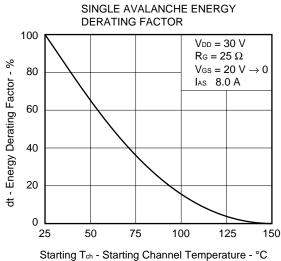














REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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Anti-radioactive design is not implemented in this product.